



RoHS

Halogen

## **Device Specification**

## **ELECTRICAL CHARACTERISTICS**

Part Number				ć		Maximum Time To Trip		Resistance	
	l <sub>hold</sub> (A)	I <sub>trip</sub> (A)	V <sub>max</sub> (Vdc)	I <sub>max</sub> (A)	P <sub>d typ</sub> (W)	Current (A)	Time (Sec.)	R <sub>min</sub> (Ω)	R <sub>1max</sub> (Ω)
SMD2920P300TF/15	3.00	5.00	15	40	1.50	8.00	20.00	0.015	0.048

**Note:** I<sub>hold</sub> = Hold current: maximum current device will pass without tripping in 23°C still air.

Itrip = Trip current: minimum current at which the device will trip in 23°C still air.

 $V_{max}$  = Maximum voltage device can withstand without damage at rated current (I max)

I<sub>max</sub> = Maximum fault current device can withstand without damage at rated voltage (V<sub>max</sub>)

 $P_{d typ}$  = Typical power dissipated from device when in the tripped state at 23 °C still air.

R<sub>min</sub> = Minimum resistance of device in initial (un-soldered) state.

R<sub>1max</sub> = Maximum resistance of device at 23°C measured one hour after tripping or reflow soldering of 260°C for 20 sec.

\*Value specified were determined using the PWB with 0.150"\*1.5oz copper traces.

\*Customer should verify the device performance in their specified conditions.

Caution: Operation beyond the specified rating may result in damage and possible arcing and flame.

Recognitions:



Note: Polystar is Polytronics's manufacturing site in China. The Polystar ID marking shall appear on smallest package.

## **PHYSICAL DIMENSIONS (mm)**

Part Number	Α		В		С		D		E	
	Min.	Max.								
SMD2920P300TF/15	6.73	7.98	4.80	5.44	0.75	1.25	0.30	2.50	0.25	2.00

**○**Specifications are subject to change without notice.